

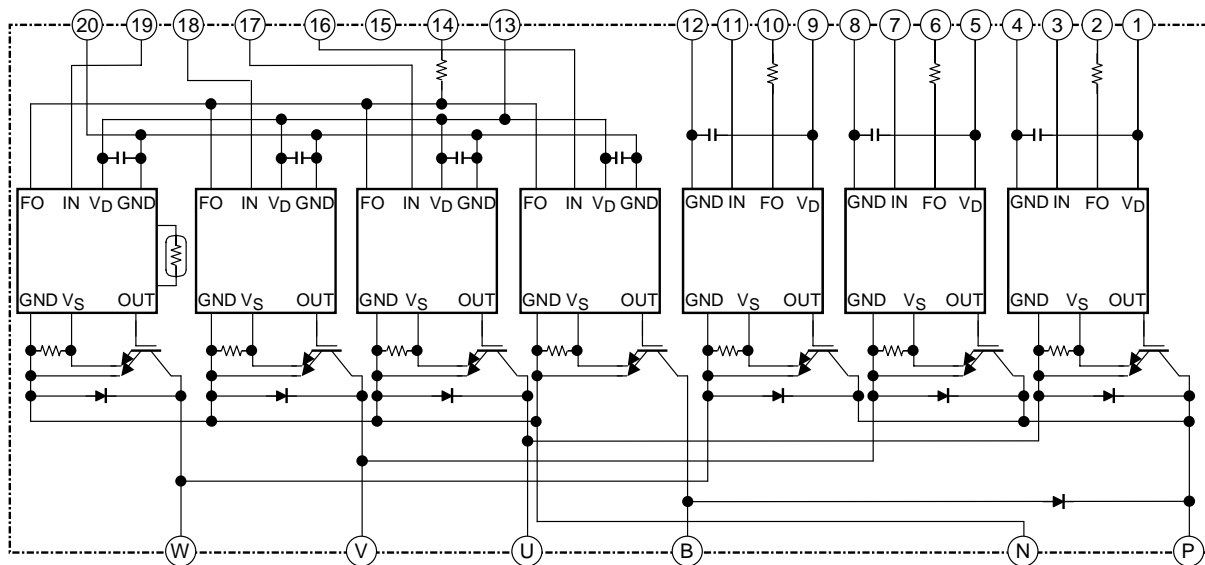
MIG150J7CSB1W (600V/150A 7in1)

High Power Switching Applications

Motor Control Applications

- Integrates inverter, brake power circuit and control circuits (IGBT drive units, and units for protection against short-circuit current, over-current, under-voltage and over-temperature) into a single package.
- The electrodes are isolated from the case
- Low thermal resistance
- $V_{CE(sat)} = 1.9\text{ V (typ.)}$
- UL recognized: File No.E87989
- Weight: 278 g (typ.)

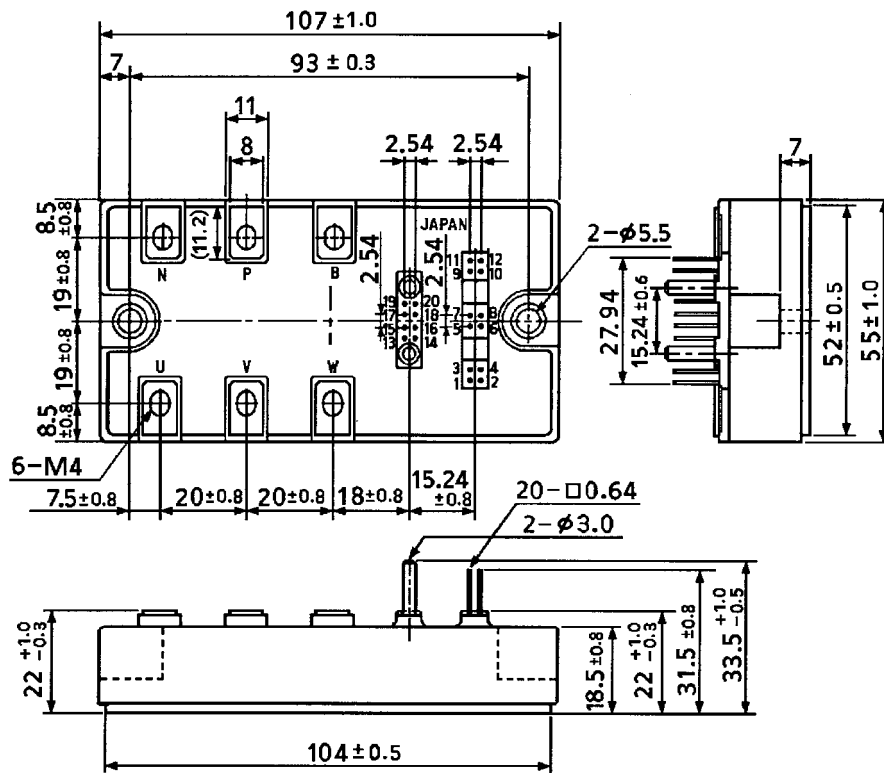
Equivalent Circuit



- | | | | | | | |
|--------------|--------------|------------|------------|--------------|---------------|------------|
| 1. V_D (U) | 2. FO (U) | 3. IN (U) | 4. GND (U) | 5. V_D (V) | 6. FO (V) | 7. IN (V) |
| 8. GND (V) | 9. V_D (W) | 10. FO (W) | 11. IN (W) | 12. GND (W) | 13. V_D (L) | 14. FO (L) |
| 15. Open | 16. IN (B) | 17. IN (X) | 18. IN (Y) | 19. IN (Z) | 20. GND (L) | |

Package Dimensions: TOSHIBA 2-108G1A

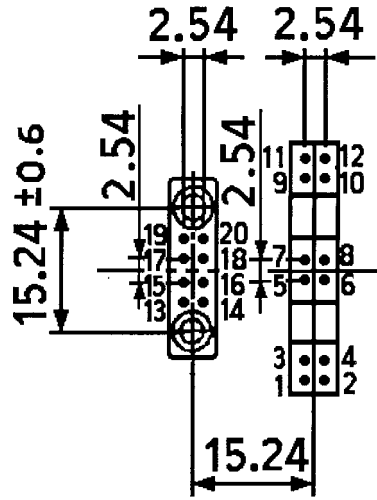
Unit: mm



- | | | | | | | | | | | | |
|-----|--------------------|-----|---------|-----|--------------------|-----|---------|-----|--------------------|-----|---------|
| 1. | V _D (U) | 2. | FO (U) | 3. | IN (U) | 4. | GND (U) | 5. | V _D (V) | 6. | FO (V) |
| 7. | IN (V) | 8. | GND (V) | 9. | V _D (W) | 10. | FO (W) | 11. | IN (W) | 12. | GND (W) |
| 13. | V _D (L) | 14. | FO (L) | 15. | Open | 16. | IN (B) | 17. | IN (X) | 18. | IN (Y) |
| 19. | IN (Z) | 20. | GND (L) | | | | | | | | |

Signal Terminal Layout

Unit: mm



- | | | | | | |
|------------------------|-------------|-----------------------|------------|-----------------------|-------------|
| 1. V _D (U) | 2. FO (U) | 3. IN (U) | 4. GND (U) | 5. V _D (V) | 6. FO (V) |
| 7. IN (V) | 8. GND (V) | 9. V _D (W) | 10. FO (W) | 11. IN (W) | 12. GND (W) |
| 13. V _D (L) | 14. FO (L) | 15. Open | 16. IN (B) | 17. IN (X) | 18. IN (Y) |
| 19. IN (Z) | 20. GND (L) | | | | |

Maximum Ratings (T_j = 25°C)

Stage	Characteristic	Condition	Symbol	Rating	Unit
Inverter	Supply voltage	P-N Power terminal	V _{CC}	450	V
	Collector-emitter voltage	—	V _{CEs}	600	V
	Collector current	T _c = 25°C, DC	I _C	150	A
	Forward current	T _c = 25°C, DC	I _F	150	A
	Collector power dissipation	T _c = 25°C, DC	P _C	740	W
	Junction temperature	—	T _j	150	°C
Brake	Supply voltage	P-N Power terminal	V _{CC}	450	V
	Collector-emitter voltage	—	V _{CEs}	600	V
	Collector current	T _c = 25°C, DC	I _C	75	A
	Reverse voltage	—	V _R	600	V
	Forward current	T _c = 25°C, DC	I _F	75	A
	Collector power dissipation	T _c = 25°C	P _C	460	W
	Junction temperature	—	T _j	150	°C
Control	Control supply voltage	V _D -GND Terminal	V _D	20	V
	Input voltage	IN-GND Terminal	V _{IN}	20	V
	Fault output voltage	FO-GND Terminal	V _{FO}	20	V
	Fault output current	FO sink current	I _{FO}	14	mA
Module	Operating temperature	—	T _c	-20~ +100	°C
	Storage temperature Range	—	T _{stg}	-40~ +125	°C
	Isolation voltage	AC 1 min	V _{ISO}	2500	V
	Screw torque (Terminal)	M4	—	2	N·m
	Screw torque (Mounting)	M5	—	3	

Electrical Characteristics

Inverter stage

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit	
Collector cut-off current	I _{CEX}	V _{CE} = 600 V	T _j = 25°C	—	—	1	mA
			T _j = 125°C	—	—	10	
Collector-emitter saturation voltage	V _{CE (sat)}	V _D = 15 V I _C = 150 A V _{IN} = 15 V → 0 V	T _j = 25°C	1.6	1.9	2.3	V
			T _j = 125°C	—	2.1	—	
Forward voltage	V _F	I _F = 150 A, T _j = 25°C	—	2.4	2.8	V	
Switching time	t _{on}	V _{CC} = 300 V, I _C = 150 A V _D = 15 V, V _{IN} = 15 V ↔ 0 V T _j = 25°C, Inductive load (Note 1)	—	1.3	2.2	μs	
	t _{c (on)}		—	0.3	—		
	t _{rr}		—	0.3	—		
	t _{off}		—	1.1	2.1		
	t _{c (off)}		—	0.2	—		

Note 1: Switching time test circuit & timing chart

Brake stage

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit	
Collector cut-off current	I_{CEX}	$V_{CE} = 600\text{ V}$	$T_J = 25^\circ\text{C}$	—	—	1	mA
			$T_J = 125^\circ\text{C}$	—	—	10	
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_D = 15\text{ V}$ $I_C = 75\text{ A}$ $V_{IN} = 15\text{ V} \rightarrow 0\text{ V}$	$T_J = 25^\circ\text{C}$	—	1.8	2.2	V
			$T_J = 125^\circ\text{C}$	—	2.0	—	
Reverse current	I_R	$V_R = 600\text{ V}$	$T_J = 25^\circ\text{C}$	—	—	1	mA
			$T_J = 125^\circ\text{C}$	—	—	10	
Forward voltage	V_F	$I_F = 75\text{ A}, T_J = 25^\circ\text{C}$	1.7	2.2	2.6	V	
Switching time	t_{on}	$V_{CC} = 300\text{ V}, I_C = 75\text{ A}$ $V_D = 15\text{ V}, V_{IN} = 15\text{ V} \leftrightarrow 0\text{ V}$ $T_J = 25^\circ\text{C}, \text{Inductive load}$ (Note 1)	—	1.6	2.2	μs	
	$t_c(\text{on})$		—	0.65	—		
	t_{rr}		—	0.45	—		
	t_{off}		—	1.4	2.4		
	$t_c(\text{off})$		—	0.2	—		

Note 1: Switching time test circuit & timing chart

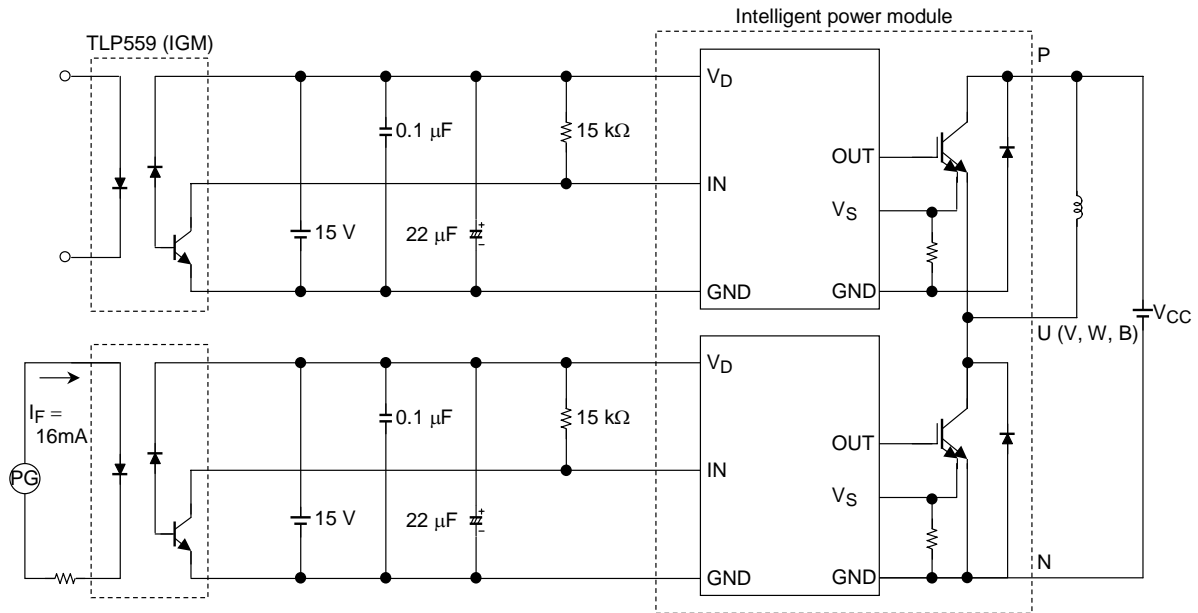
Control stage ($T_J = 25^\circ\text{C}$)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Control circuit current	High side	$V_D = 15\text{ V}$	—	13	17	mA
	Low side		—	52	68	
Input on signal voltage	$V_{IN(\text{on})}$	$V_D = 15\text{ V}$	1.4	1.6	1.8	V
Input off signal voltage	$V_{IN(\text{off})}$		2.2	2.5	2.8	
Fault output current	Protection	$V_D = 15\text{ V}$	—	10	12	mA
	Normal		—	—	0.1	
Over current protection trip level	Inverter	$V_D = 15\text{ V}, T_J \leq 125^\circ\text{C}$	240	—	—	A
	Brake		120	—	—	
Short circuit protection trip level	Inverter	$V_D = 15\text{ V}, T_J \leq 125^\circ\text{C}$	240	—	—	A
	Brake		120	—	—	
Over current cut-off time	$t_{off(OC)}$	$V_D = 15\text{ V}$	—	5	—	μs
Over temperature protection	Trip level	Case temperature	110	118	125	$^\circ\text{C}$
	Reset level		—	98	—	
Control supply under voltage protection	Trip level	—	11.0	12.0	12.5	V
	Reset level		12.0	12.5	13.0	
Fault output pulse width	t_{FO}	$V_D = 15\text{ V}$	1	2	3	ms

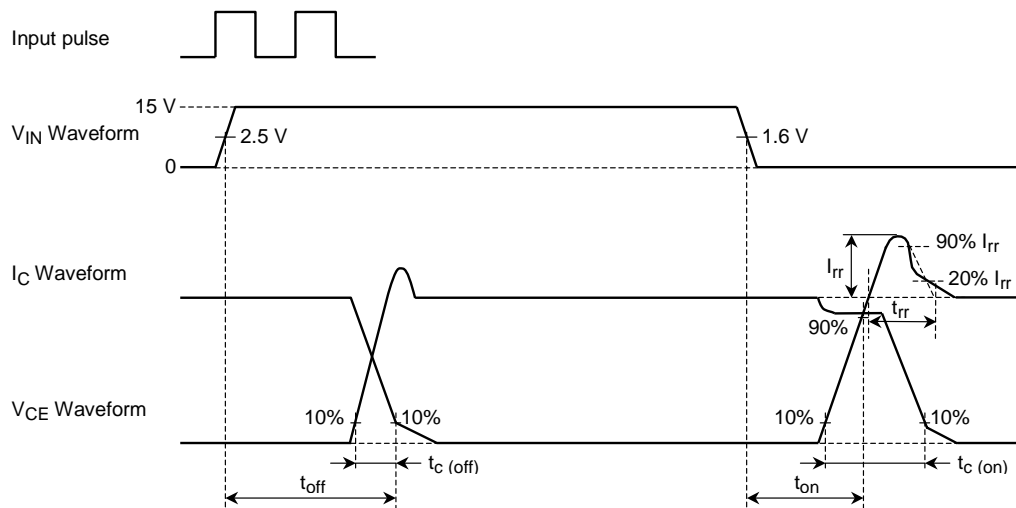
Thermal resistance ($T_c = 25^\circ\text{C}$)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Junction to case thermal resistance	$R_{th(j-c)}$	Inverter IGBT	—	—	0.167	$^\circ\text{C/W}$
		Inverter FRD	—	—	0.313	
		Brake IGBT	—	—	0.270	
		Brake FRD	—	—	0.600	
Case to fin thermal resistance	$R_{th(c-f)}$	Compound is applied	—	0.017	—	$^\circ\text{C/W}$

Switching Time Test Circuit



Timing Chart

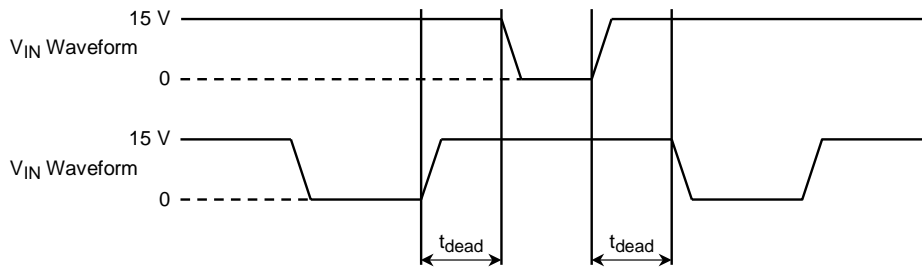


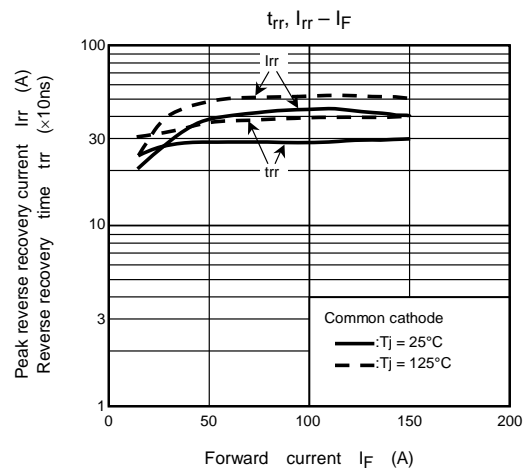
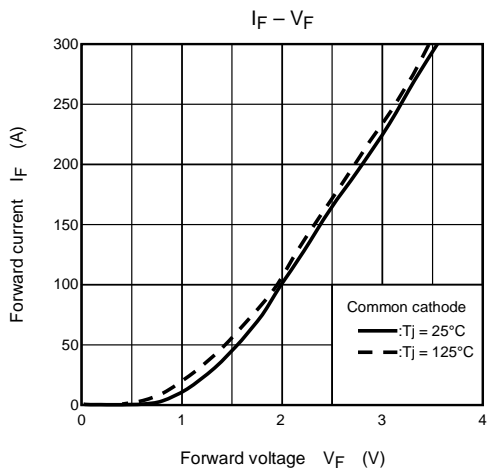
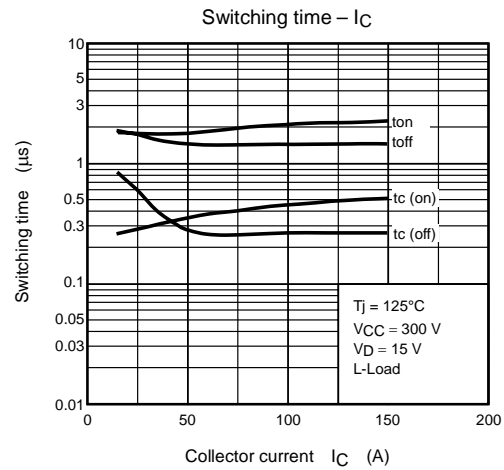
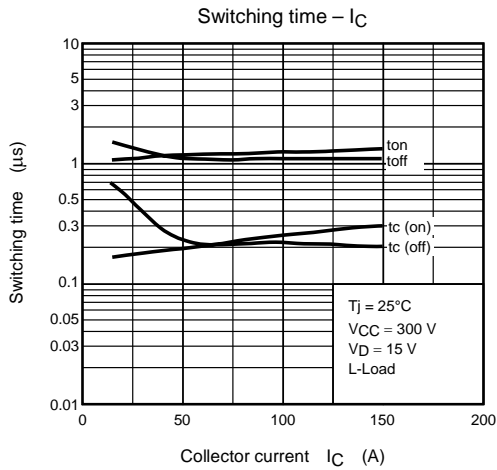
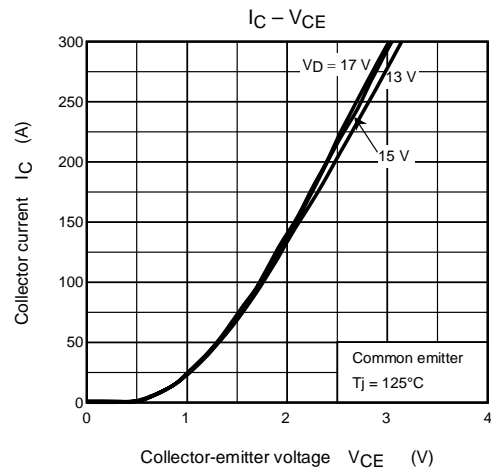
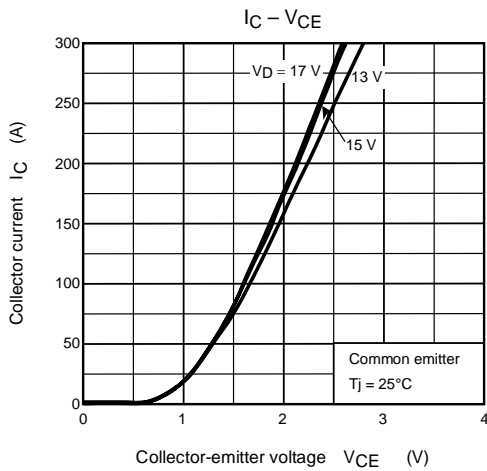
Recommended conditions for application

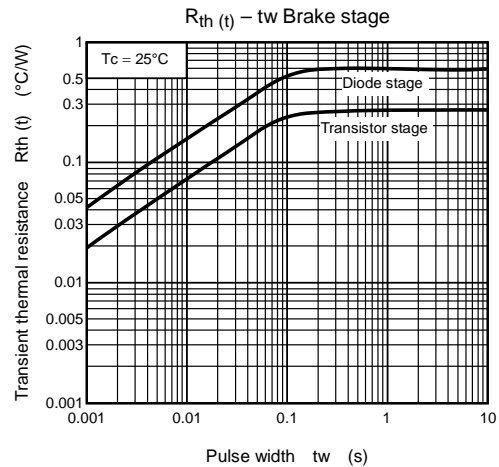
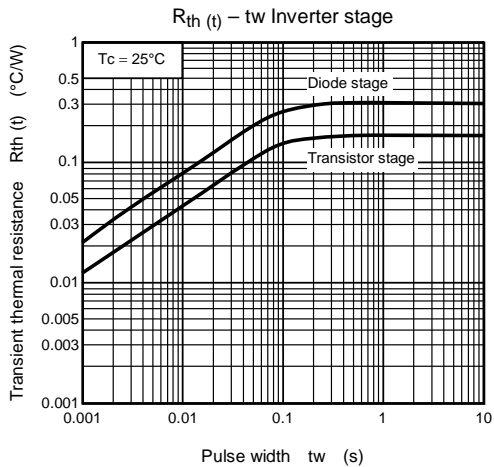
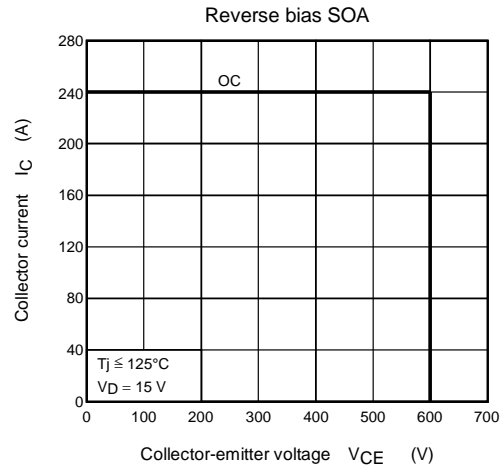
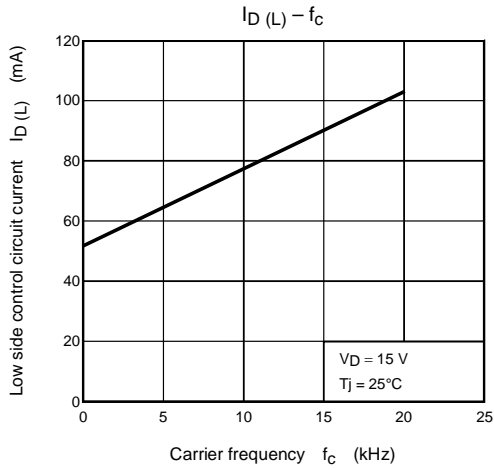
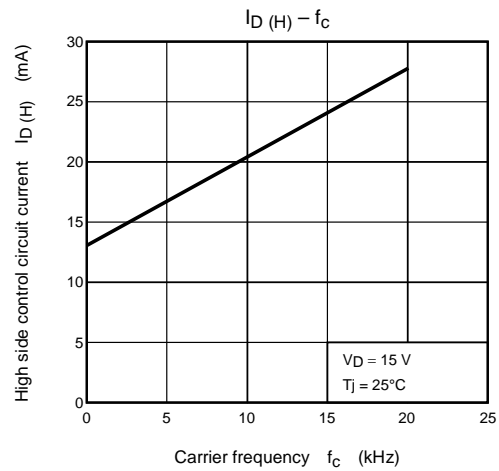
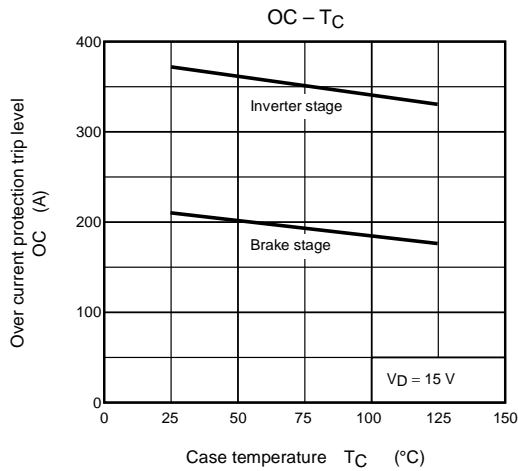
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Supply voltage	V_{CC}	P-N Power terminal	—	300	400	V
Control supply voltage	V_D	V_D -GND Signal terminal	13.5	15	16.5	V
Carrier frequency	f_c	PWM Control	—	—	20	kHz
Dead time	t_{dead}	Switching time test circuit (See page.6) (Note 2)	3	—	—	μs

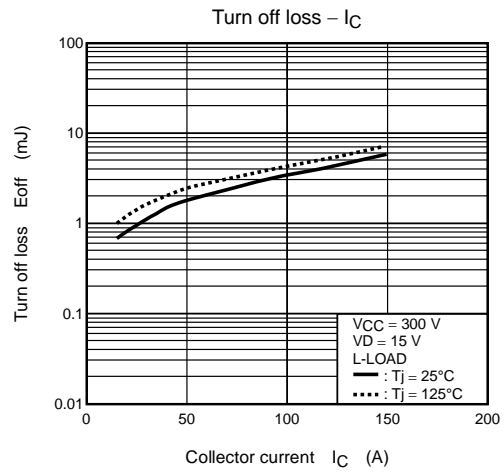
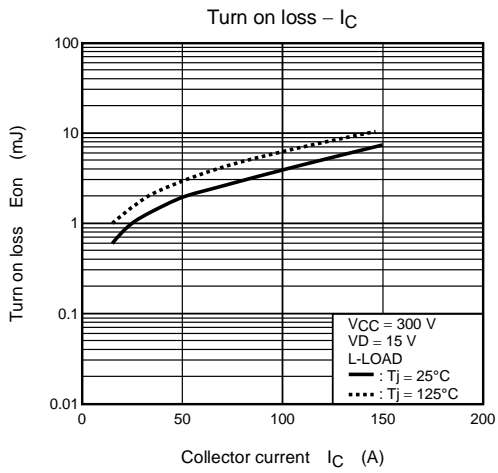
Note 2: The table lists Dead time requirements for the module input, excluding photocoupler delays. When specifying dead time requirements for the photocoupler input, please add photocoupler delays to the dead time given above.

Dead Time Timing Chart









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